
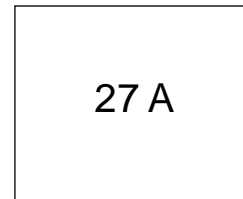


### THYRISTOR/ DIODE and THYRISTOR/ THYRISTOR

### NEWADD-A-pak™ Power Modules

#### Features

- Electrically isolated: DBC base plate
- 3500 V<sub>RMS</sub> isolating voltage
- Standard JEDEC package
- Simplified mechanical designs, rapid assembly
- Auxiliary cathode terminals for wiring convenience
- High surge capability
- Wide choice of circuit configurations
- Large creepage distances
- UL E78996 approved 



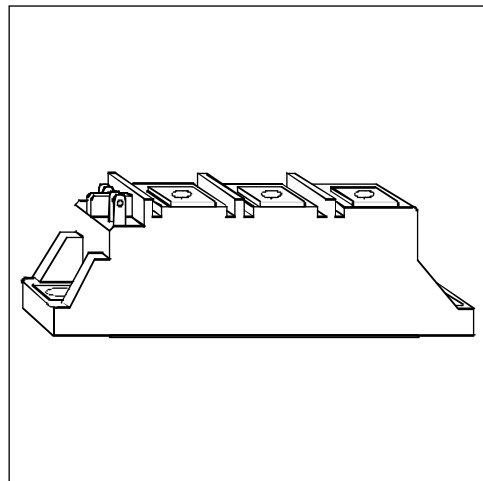
#### Description

These IRK series of NEW ADD-A-paks use power diodes and thyristors in a variety of circuit configurations. The semiconductor chips are electrically isolated from the base plate, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or AC controllers. These modules are intended for general purpose high voltage applications such as high voltage regulated power supplies, lighting circuits, and temperature and motor speed control circuits.

#### Major Ratings and Characteristics

Parameters	IRK.26	Units
$I_{T(AV)}$ or $I_{F(AV)}$ @ 85°C	27	A
$I_{O(RMS)}$ (*)	60	A
$I_{TSM}$ @ 50Hz	400	A
$I_{FSM}$ @ 60Hz	420	A
$i^2t$ @ 50Hz	800	A <sup>2</sup> s
@ 60Hz	730	A <sup>2</sup> s
$i^2\sqrt{t}$	8000	A <sup>2</sup> √s
V <sub>RRM</sub> range	400 to 1600	V
T <sub>STG</sub>	-40 to 125	°C
T <sub>J</sub>	-40 to 125	°C

(\*) As AC switch.



## IRK.26 Series

Bulletin I27130 rev. C 09/97

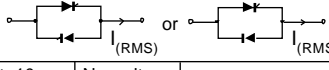
International  
IR Rectifier

### ELECTRICAL SPECIFICATIONS

#### Voltage Ratings

Type number	Voltage Code	$V_{RRM}$ , maximum repetitive peak reverse voltage	$V_{RSM}$ , maximum non-repetitive peak reverse voltage	$V_{DRM}$ , max. repetitive peak off-state voltage, gate open circuit	$I_{RRM}$ , $I_{DRM}$ 125°C
	-	V	V	V	mA
IRK.26	04	400	500	400	15
	06	600	700	600	
	08	800	900	800	
	10	1000	1100	1000	
	12	1200	1300	1200	
	14	1400	1500	1400	
	16	1600	1700	1600	

#### On-state Conduction

Parameters	IRK.26	Units	Conditions											
$I_{T(AV)}$ Max. average on-state current (Thyristors)	27	A	180° conduction, half sine wave, $T_C = 85^\circ\text{C}$											
$I_{F(AV)}$ Max. average forward current (Diodes)	27													
$I_{O(RMS)}$ Max. continuous RMS on-state current. As AC switch	60													
$I_{TSM}$ Max. peak, one cycle or non-repetitive on-state current	400	A												
$I_{FSM}$ or forward current	420			$t=10\text{ms}$ No voltage reappplied	Sinusoidal half wave, Initial $T_J = T_J \text{ max.}$									
	335			$t=8.3\text{ms}$ 100% $V_{RRM}$ reappplied										
	350			$t=10\text{ms}$ $T_J = 25^\circ\text{C}$ ,										
	470			$t=8.3\text{ms}$ no voltage reappplied										
	490													
$I^2t$ Max. $I^2t$ for fusing	800	$\text{A}^2\text{s}$	<table border="1"> <tr> <td><math>t=10\text{ms}</math></td> <td>No voltage reappplied</td> <td rowspan="2">Initial <math>T_J = T_J \text{ max.}</math></td> </tr> <tr> <td><math>t=8.3\text{ms}</math></td> <td>100% <math>V_{RRM}</math> reappplied</td> </tr> <tr> <td><math>t=10\text{ms}</math></td> <td><math>T_J = 25^\circ\text{C}</math>,</td> <td></td> </tr> <tr> <td><math>t=8.3\text{ms}</math></td> <td>no voltage reappplied</td> <td></td> </tr> </table>	$t=10\text{ms}$		No voltage reappplied	Initial $T_J = T_J \text{ max.}$	$t=8.3\text{ms}$	100% $V_{RRM}$ reappplied	$t=10\text{ms}$	$T_J = 25^\circ\text{C}$ ,		$t=8.3\text{ms}$	no voltage reappplied
$t=10\text{ms}$	No voltage reappplied			Initial $T_J = T_J \text{ max.}$										
$t=8.3\text{ms}$	100% $V_{RRM}$ reappplied													
$t=10\text{ms}$	$T_J = 25^\circ\text{C}$ ,													
$t=8.3\text{ms}$	no voltage reappplied													
	730													
	560													
	510													
	1100													
	1000													
$I^2\sqrt{t}$ Max. $I^2\sqrt{t}$ for fusing (1)	8000	$\text{A}^2\sqrt{\text{s}}$	$t=0.1$ to $10\text{ms}$ , no voltage reappli. $T_J = T_J \text{ max.}$											
$V_{T(TO)}$ Max. value of threshold voltage (2)	0.92	V	Low level (3)	$T_J = T_J \text{ max.}$										
	0.95		High level (4)											
$r_t$ Max. value of on-state slope resistance (2)	12.11	$\text{m}\Omega$	Low level (3)	$T_J = T_J \text{ max.}$										
	11.82		High level (4)											
$V_{TM}$ Max. peak on-state or forward voltage	1.95	V	$I_{TM} = \pi \times I_{T(AV)}$	$T_J = 25^\circ\text{C}$										
$V_{FM}$			$I_{FM} = \pi \times I_{F(AV)}$											
$di/dt$ Max. non-repetitive rate of rise of turned on current	150	$\text{A}/\mu\text{s}$	$T_J = 25^\circ\text{C}$ , from $0.67 V_{DRM}$ , $I_{TM} = \pi \times I_{T(AV)}$ , $I_g = 500\text{mA}$ , $t_r < 0.5 \mu\text{s}$ , $t_p > 6 \mu\text{s}$											
$I_H$ Max. holding current	200	mA	$T_J = 25^\circ\text{C}$ , anode supply = 6V, resistive load, gate open circuit											
$I_L$ Max. latching current	400		$T_J = 25^\circ\text{C}$ , anode supply = 6V, resistive load											

- (1)  $I^2t$  for time  $t_x = I^2\sqrt{t} \times \sqrt{t_x}$  (2) Average power =  $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^2$  (3)  $16.7\% \times \pi \times I_{AV} < I < \pi \times I_{AV}$   
 (4)  $I > \pi \times I_{AV}$

### Triggering

Parameters	IRK.26	Units	Conditions	
$P_{GM}$ Max. peak gate power	10	W		
$P_{G(AV)}$ Max. average gate power	2.5			
$I_{GM}$ Max. peak gate current	2.5	A		
$-V_{GM}$ Max. peak negative gate voltage	10	V	Anode supply = 6V resistive load	
$V_{GT}$ Max. gate voltage required to trigger	4.0			$T_J = -40^\circ\text{C}$
	2.5			$T_J = 25^\circ\text{C}$
	1.7	$T_J = 125^\circ\text{C}$		
$I_{GT}$ Max. gate current required to trigger	270	mA	Anode supply = 6V resistive load	
	150			$T_J = -40^\circ\text{C}$
	80			$T_J = 125^\circ\text{C}$
$V_{GD}$ Max. gate voltage that will not trigger	0.25	V	$T_J = 125^\circ\text{C}$ , rated $V_{DRM}$ applied	
$I_{GD}$ Max. gate current that will not trigger	6	mA	$T_J = 125^\circ\text{C}$ , rated $V_{DRM}$ applied	

### Blocking

Parameters	IRK.26	Units	Conditions
$I_{RRM}$ Max. peak reverse and off-state leakage current at $V_{RRM}$ , $V_{DRM}$	15	mA	$T_J = 125^\circ\text{C}$ , gate open circuit
$V_{INS}$ RMS isolation voltage	2500 (1 min) 3500 (1 sec)	V	50 Hz, circuit to base, all terminals shorted
dv/dt Max. critical rate of rise of off-state voltage (5)	500	V/ $\mu\text{s}$	$T_J = 125^\circ\text{C}$ , linear to $0.67 V_{DRM}$ , gate open circuit

(5) Available with dv/dt = 1000V/ $\mu\text{s}$ , to complete code add S90 i.e. IRKT26/16 S90.

### Thermal and Mechanical Specifications

Parameters	IRK.26	Units	Conditions
$T_J$ Junction operating temperature range	- 40 to 125	$^\circ\text{C}$	
$T_{stg}$ Storage temp. range	- 40 to 125		
$R_{thJC}$ Max. internal thermal resistance, junction to case	0.31	K/W	Per module, DC operation
$R_{thCS}$ Typical thermal resistance case to heatsink	0.1		Mounting surface flat, smooth and greased. Flatness < 0.03 mm; roughness < 0.02 mm
T Mounting torque $\pm 10\%$ to heatsink busbar	5	Nm	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound
	3		
wt Approximate weight	83 (3)	g (oz)	
Case style	TO-240AA		JEDEC

## IRK.26 Series

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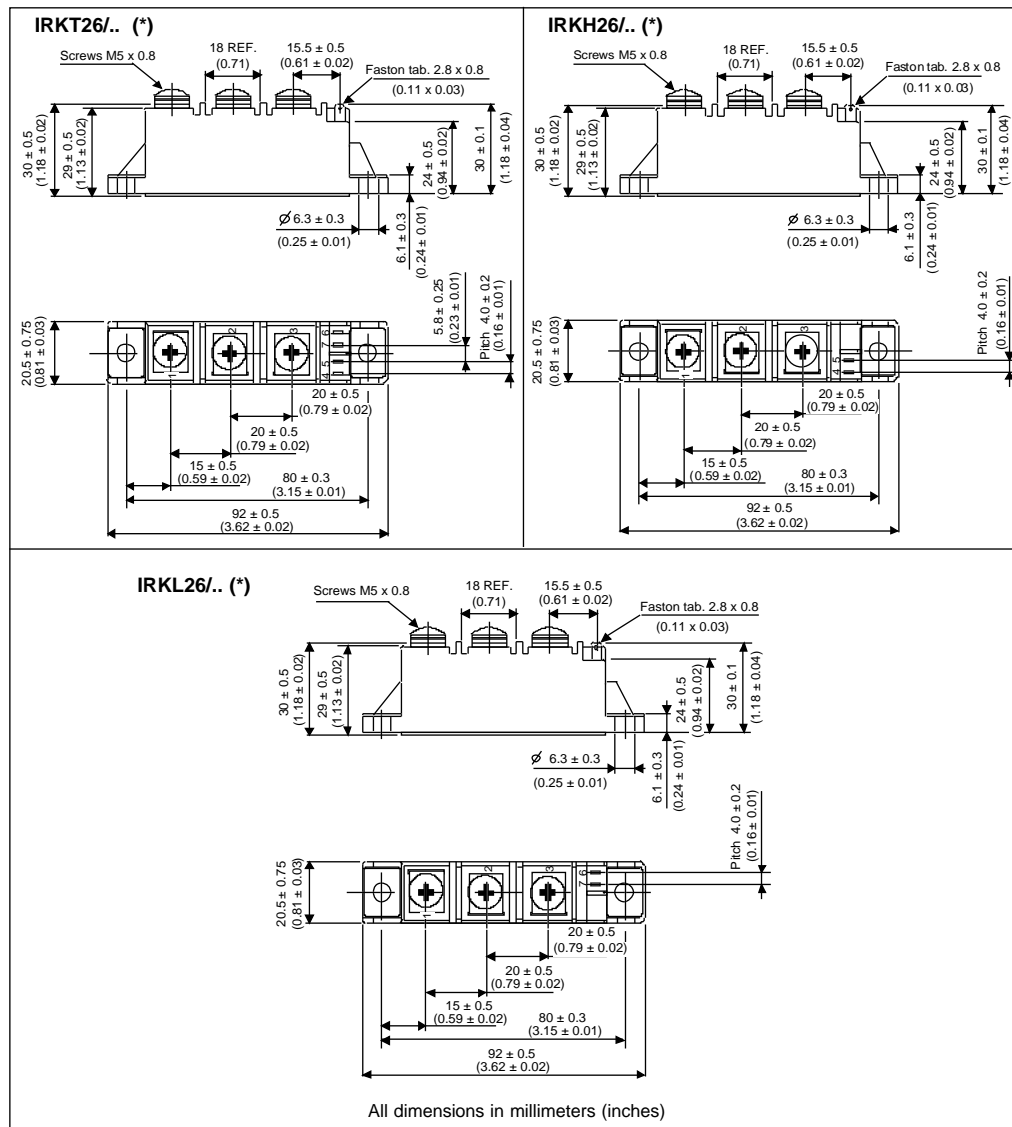
International  
IR Rectifier

### ΔR Conduction (per Junction)

(The following table shows the increment of thermal resistance  $R_{thJC}$  when devices operate at different conduction angles than DC)

Devices	Sine half wave conduction					Rect. wave conduction					Units
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
IRK.26	0.23	0.27	0.34	0.48	0.73	0.17	0.28	0.36	0.49	0.73	°C/W

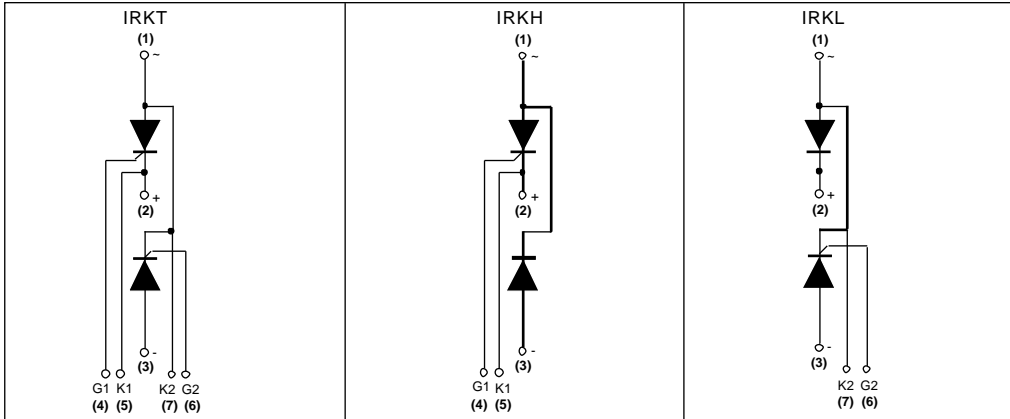
### Outlines Table



(\*) For terminals connections, see Circuit configurations Table

**NOTE: To order the Optional Hardware see Bulletin I27900**

Circuit Configurations Table



Ordering Information Table

Device Code				
IRK	T	26	/	16
①	②	③	④	⑤

- 1** - Module type
- 2** - Circuit configuration (See Circuit Configuration table)
- 3** - Current code\*\*
- 4** - Voltage code (See Voltage Ratings table)
- 5** - dv/dt code: S90 = dv/dt 1000 V/μs  
No letter = dv/dt 500 V/μs

IRK.27 types  
With no auxiliary cathode

\*\* Available with no auxiliary cathode.  
To specify change: 26 to 27  
e.g. : IRKT27/16 etc.

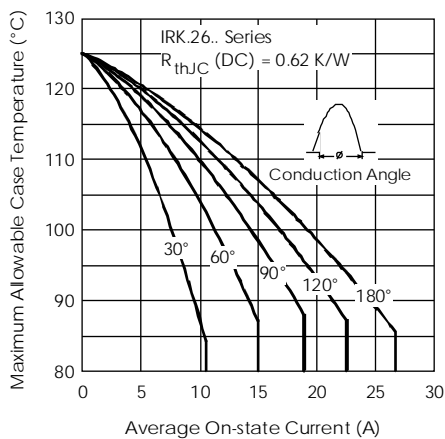


Fig. 1 - Current Ratings Characteristics

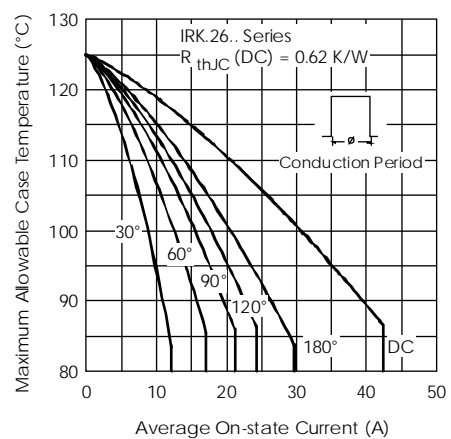


Fig. 2 - Current Ratings Characteristics

**IRK.26 Series**

Bulletin I27130 rev. C 09/97

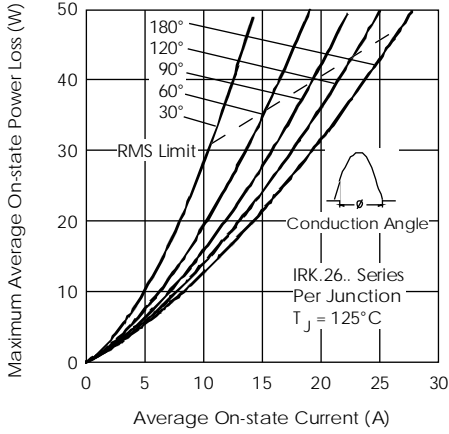


Fig. 3 - On-state Power Loss Characteristics

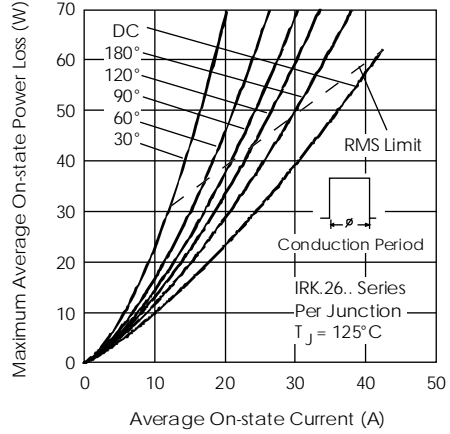


Fig. 4 - On-state Power Loss Characteristics

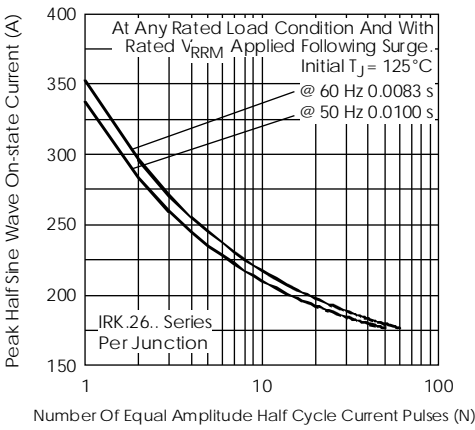


Fig. 5 - Maximum Non-Repetitive Surge Current

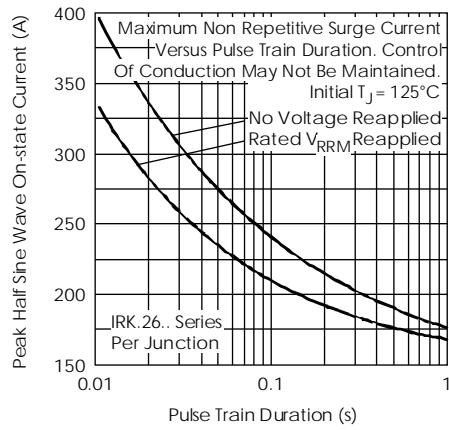


Fig. 6 - Maximum Non-Repetitive Surge Current

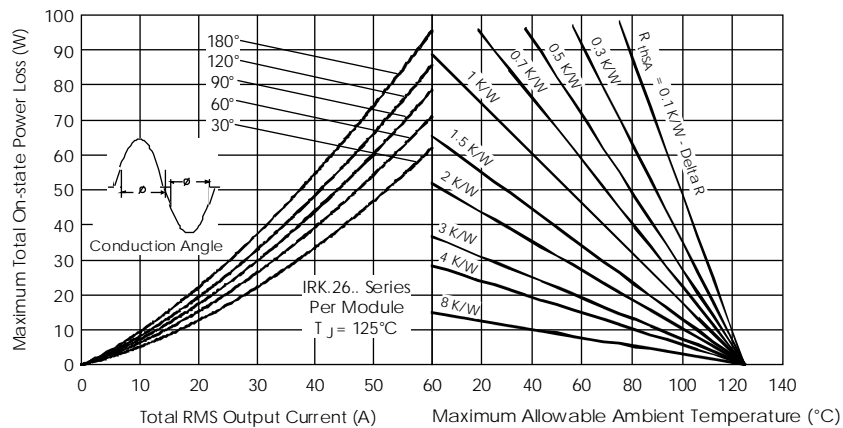


Fig. 7 - On-state Power Loss Characteristics

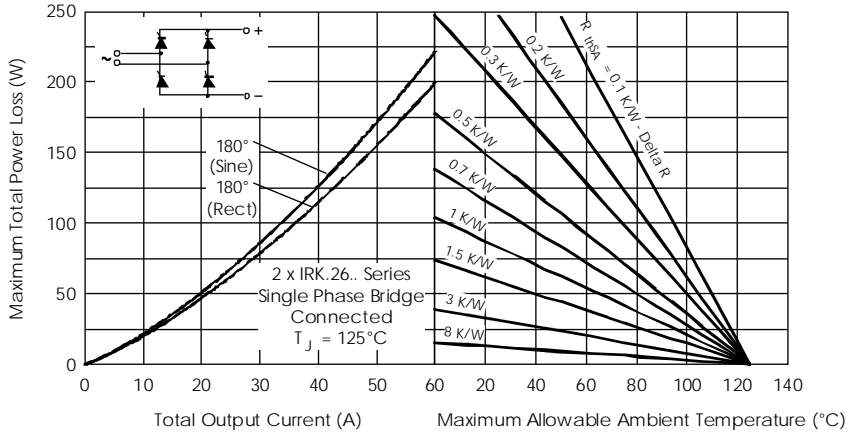


Fig. 8 - On-state Power Loss Characteristics

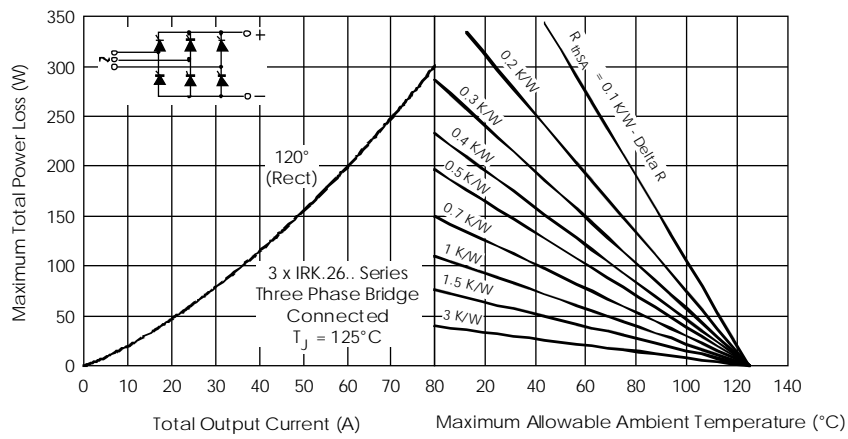


Fig. 9 - On-state Power Loss Characteristics

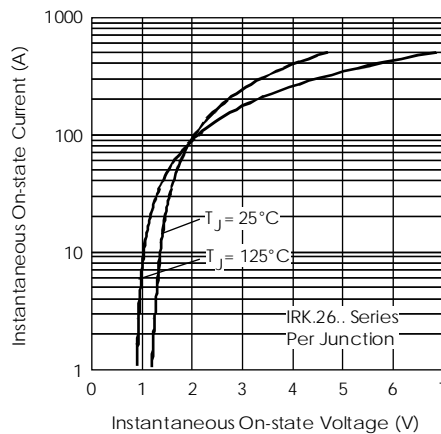


Fig. 10 - On-state Voltage Drop Characteristics

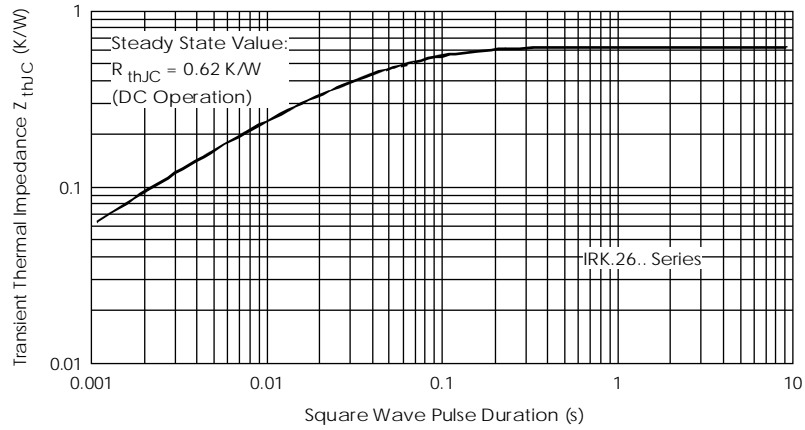


Fig. 11 - Thermal Impedance  $Z_{thJC}$  Characteristics

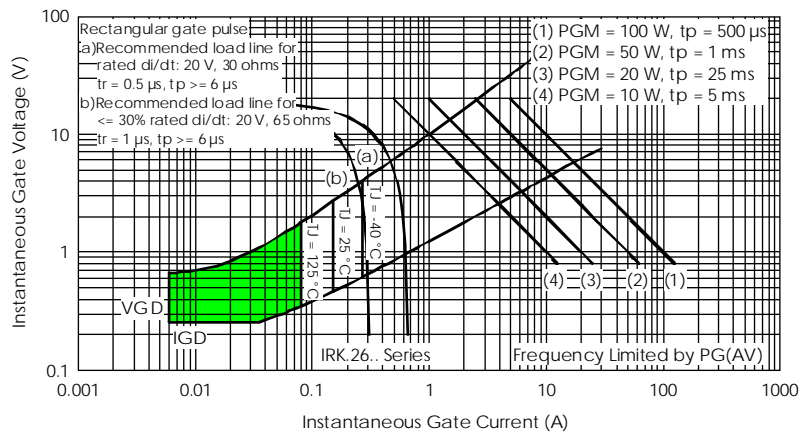


Fig. 12- Gate Characteristics